

## **General Description**

The MAX3314E is a ±5V-powered EIA/TIA-232-compatible interface. It has one transmitter and one receiver in a flow-through architecture. The transmitter output and the receiver input are protected to ±15kV using IEC 1000-4-2 Air-Gap Discharge, ±8kV using IEC 1000-4-2 Contact Discharge, and ±15kV using the Human Body Model.

The transmitter has a low-dropout output stage providing minimum RS-232-compatible ±3.7V output levels while driving  $3k\Omega$  and 1000pF at 460kbps. Both +5Vand -5V must be supplied externally.

The MAX3314E has a SHDN function that reduces supply current to 1µA. The transmitter is disabled and put into tristate while the receiver remains active.

The MAX3314E is available in 8-pin µMAX, SOT23, and SO packages.

### **Applications**

Digital Cameras

**PDAs** 

**GPS** 

POS

Telecommunications

Handy-Terminals

Set-Top Boxes

#### Features

- ♦ ESD Protection for RS-232 I/O Pins ±15kV—Human Body Model ±8kV—IEC 1000-4-2 Contact Discharge ±15kV—IEC 1000-4-2 Air-Gap Discharge
- ♦ 1µA Low-Power Shutdown with Receiver Active
- ♦ 30µA Operating Supply Current
- ♦ 460kbps Guaranteed Data Rate
- ♦ 8-Pin SOT23 Package
- ♦ ±3.7V RS-232-Compatible Levels

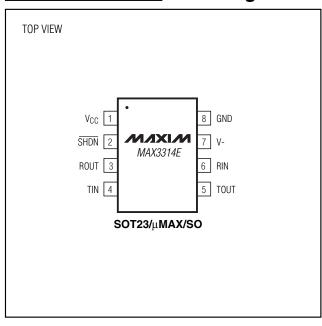
## **Ordering Information**

PART	TEMP. RANGE	PIN-PACKAGE
MAX3314ECKA-T	0°C to +70°C	8 SOT23-8
MAX3314ECUA	0°C to +70°C	8 μMAX
MAX3314ECSA	0°C to +70°C	8 SO
MAX3314EEKA-T	-40°C to +85°C	8 SOT23-8
MAX3314EEUA	-40°C to +85°C	8 μMAX
MAX3314EESA	-40°C to +85°C	8 SO

### Typical Operating Circuit

# CBYPASS 0.1µF Vcc SHDN NIXIN V. MAX3314E TOUT RIN $\leq_{5k\Omega}$ CAPACITORS MAY BE POLARIZED OR NONPOLARIZED.

## Pin Configuration



MIXIM

Maxim Integrated Products 1

#### **ABSOLUTE MAXIMUM RATINGS**

V <sub>CC</sub> to GNDV- to GND		Continuous Pov 8-Pin SOT23
	+0.37 10 -67	
Input Voltages		8-Pin µMAX (
TIN, SHDN to GND	0.3V to +6V	8-Pin SO (de
RIN to GND	±25V	Operating Tem
Output Voltages		MAX3314EC
	±13.2V	MAX3314EE
ROUT	0.3V to (V <sub>CC</sub> + 0.3V)	Junction Tempe
Short-Circuit Duration		Storage Tempe
TOUT to GND	Continuous	Lead Temperat

Continuous Power Dissipation	
8-Pin SOT23 (derate 9.7mW/°C above	+70°C)777mW
8-Pin µMAX (derate 4.1mW/°C above +	70°C)300mW
8-Pin SO (derate 5.88mW/°C above +7	0°C)471mW
Operating Temperature Ranges	
MAX3314EC_A	0°C to +70°C
MAX3314EE_A	40°C to +85°C
Junction Temperature	+150°C
Storage Temperature Range	65°C to +150°C
Lead Temperature (soldering, 10s)	+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

#### **ELECTRICAL CHARACTERISTICS**

(V<sub>CC</sub> = +5V, V- = -5V, T<sub>A</sub> = T<sub>MIN</sub> to T<sub>MAX</sub>. Typical values are at T<sub>A</sub> = +25°C.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS		
DC CHARACTERISTICS								
Positive Supply Operating Range	Vcc		4.75	5	5.25	V		
Negative Supply Operating Range	V-		-4.75	-5	-5.25	V		
Positive Supply Current		SHDN = V <sub>CC</sub> , no load		30	100	μΑ		
Negative Supply Current		SHDN = V <sub>CC</sub> , no load		15	30	μΑ		
Shutdown Supply Current		SHDN = GND		1	10	μΑ		
LOGIC INPUTS (TIN, SHDN)								
Input Logic Threshold Low	VIL		0.8			V		
Input Logic Threshold High	VIH				2.4	V		
Transmitter Input Hysteresis				0.5		V		
Input Leakage Current				±0.01		μΑ		
RECEIVER OUTPUT								
Output Voltage Low	V <sub>OL</sub>	$I_{OUT} = 1.6$ mA			0.4	V		
Output Voltage High	V <sub>OH</sub>	I <sub>OUT</sub> = -1.0mA	V <sub>C</sub> C - 0.3	V <sub>C</sub> C - 0.1		V		
RECEIVER INPUT	1		I			I		
Input Threshold Low	V <sub>IL</sub>		0.8			V		
Input Threshold High	VIH				2.4	V		
Input Hysteresis				0.5		V		
Input Resistance				5		kΩ		
TRANSMITTER OUTPUT								
Output Voltage Swing		Transmitter output loaded with $3k\Omega$ to ground	±3.7			V		
Output Resistance (Note 1)		$V_{CC} = V_{-} = 0$ , transmitter output = $\pm 2V$	300			Ω		
Output Short-Circuit Current					±60	mA		
Output Leakage Current		V <sub>OUT</sub> = ±12V, transmitter disabled			25	μΑ		
ESD PROTECTION (Transmitter C	Output, Rece	iver Input)						
		Human Body Model		±15				
ESD-Protection Voltage		IEC 1000-4-2 Air-Gap Discharge		±15		kV		
		IEC 1000-4-2 Contact Discharge		±8				

#### **TIMING CHARACTERISTICS**

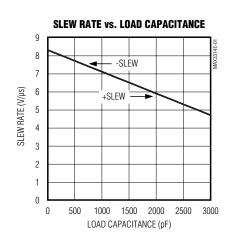
( $V_{CC}$  = +5V, V- = -5V,  $T_A$  =  $T_{MIN}$  to  $T_{MAX}$ . Typical values are at  $T_A$  = +25°C.)

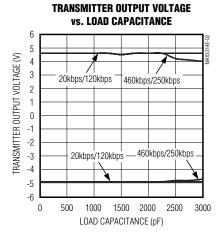
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Maximum Data Rate		$R_L = 3k\Omega$ , $C_L = 1000pF$ , transmitter switching	460			kbps
Descriver Propagation Delay	tpLH	Receiver input to receiver output, C <sub>L</sub> = 150pF	0.15			
Receiver Propagation Delay	tpHL	Receiver input to receiver output, C <sub>L</sub> = 150pF		0.15		μs
Transmitter Skew				100		ns
Receiver Skew				50		ns
Transition Region Slew Rate		$R_L = 3k\Omega$ to $7k\Omega$ , $C_L = 150pF$ to 1000pF, measured from +3V to -3V or -3V to +3V		8		V/µs

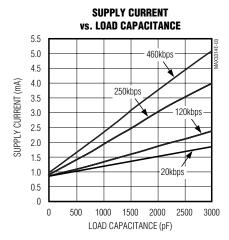
Note 1: Not tested, guaranteed by design.

# \_Typical Operating Characteristics

 $(V_{CC} = +5V, V_{-} = -5V, 250 \text{kbps}$  data rate, transmitter loaded with  $3k\Omega$  and  $C_L$ ,  $T_A = +25^{\circ}C$ , unless otherwise noted.)







## **Pin Description**

PIN	NAME	FUNCTION
1	V <sub>CC</sub>	+5V ±5% External Power Supply. Decouple with a 0.1μF capacitor to ground.
2	SHDN	Shutdown, Active low (0 = off, 1 = on).
3	ROUT	TTL/CMOS Receiver Output
4	TIN	TTL/CMOS Transmitter Input
5	TOUT	RS-232-Compatible Transmitter Output
6	RIN	RS-232-Compatible Receiver Input
7	V-	-5V ±5% External Power Supply. Decouple with a 0.1μF capacitor to ground.
8	GND	Ground

## **Detailed Description**

#### **RS-232-Compatible Drivers**

The transmitter is an inverting level translator that converts CMOS-logic levels to  $\pm 3.7 V$  EIA/TIA-232-compatible levels. It guarantees data rates up to 460kbps with worst-case loads of  $3 k\Omega$  in parallel with 1000pF. When  $\overline{SHDN}$  is driven low, the transmitter is disabled and put into tristate. The transmitter input does not have a pull-up resistor. Connect to ground if unused.

#### RS-232-Compatible Receivers

The MAX3314E's receiver converts RS-232 signals to CMOS-logic output levels. The receiver is rated to receive signals to ±25V. It will remain active during shutdown mode.

#### MAX3314E Shutdown Mode

In shutdown mode, the transmitter output is put into high impedance (Table 1). This reduces supply current to 1 $\mu$ A. The time required to exit shutdown is less than 2.5 $\mu$ s.

# Applications Information

#### **Capacitor Selection**

The capacitor type used is not critical for proper operation; either polarized or nonpolarized capacitors are acceptable. If polarized capacitors are used, connect polarity as shown in the *Typical Operating Circuit*.

Bypass VCC and V- to ground with at least 0.1µF.

# Transmitter Outputs When Exiting Shutdown

Figure 1 shows the transmitter output when exiting shutdown mode. The transmitter is loaded with  $3k\Omega$  in

parallel with 1000pF. The transmitter output displays no ringing or undesirable transients as the MAX3314E comes out of shutdown.

#### **High Data Rates**

The MAX3314E maintains minimum RS-232-compatible ±3.7V transmitter output voltage even at high data rates. Figure 2 shows a transmitter loopback test circuit. Figure 3 shows the loopback test result at 120kbps, and Figure 4 shows the same test at 250kbps.

#### ±15kV ESD Protection

As with all Maxim devices, ESD-protection structures are incorporated on all pins to protect against electrostatic discharges encountered during handling and assembly. The MAX3314E driver outputs and receiver inputs have extra protection against static discharge. Maxim's engineers have developed state-of-the-art structures to protect these pins against ESD of ±15kV without damage. The ESD structures withstand high ESD in all states: normal operation, shutdown, and powered down. After an ESD event, Maxim's E versions keep working without latchup, whereas competing products can latch and must be powered down to remove latchup.

ESD protection can be tested in various ways. The transmitter outputs and receiver inputs of the product family are characterized for protection to the following limits:

- ±15kV using the Human Body Model
- ±8kV using the Contact Discharge method specified in IEC 1000-4-2
- ±15kV using the IEC 1000-4-2 Air-Gap method

**Table 1. Shutdown Logic Truth Table** 

SHDN	TRANSMITTER OUTPUT	RECEIVER OUTPUT	
L	High Z	Active	
Н	Active	Active	

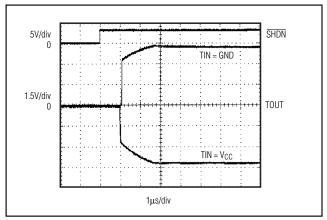


Figure 1. Transmitter Outputs When Exiting Shutdown or Powering Up

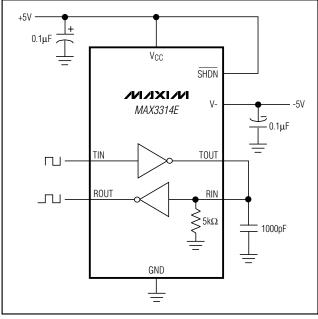


Figure 2. Loopback Test Circuit

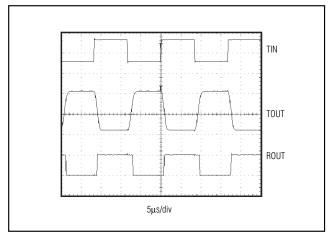


Figure 3. Loopback Test Result at 120kbps

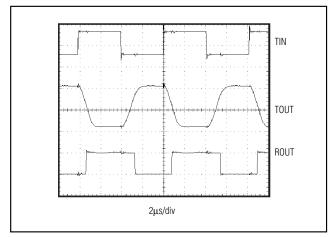


Figure 4. Loopback Test Result at 250kbps

#### **ESD Test Conditions**

ESD performance depends on a variety of conditions. Contact Maxim for a reliability report that documents test setup, test methodology, and test results.

#### **Human Body Model**

Figure 5 shows the Human Body Model, and Figure 6 shows the current waveform it generates when discharged into low impedance. This model consists of a 100pF capacitor charged to the ESD voltage of interest, which is then discharged into the test device through a  $1.5 \mathrm{k}\Omega$  resistor.

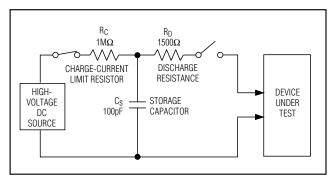


Figure 5. Human Body ESD Test Model

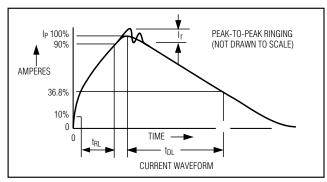


Figure 6. Human Body Current Waveform

#### IEC 1000-4-2

The IEC 1000-4-2 standard covers ESD testing and performance of finished equipment; it does not specifically refer to ICs. The MAX3314E helps design equipment that meets Level 4 (the highest level) of IEC 1000-4-2 without the need for additional ESD-protection components.

The major difference between tests done using the Human Body Model and IEC 1000-4-2 is higher peak current in IEC 1000-4-2 because series resistance is lower in the IEC 1000-4-2 model. Hence, the ESD withstand voltage measured to IEC 1000-4-2 is generally lower than that measured using the Human Body Model. Figure 7 shows the IEC 1000-4-2 model, and Figure 8 shows the current waveform for the 8kV, IEC 1000-4-2, Level 4, ESD Contact Discharge test.

The Air-Gap test involves approaching the device with a charged probe. The Contact Discharge method connects the probe to the device before the probe is energized.

#### **Machine Model**

The Machine Model for ESD tests all pins using a 200pF storage capacitor and zero discharge resistance. Its objective is to emulate the stress caused by

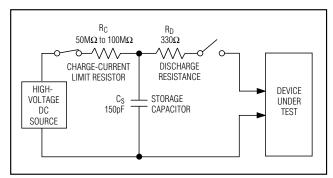


Figure 7. IEC 1000-4-2 ESD Test Model

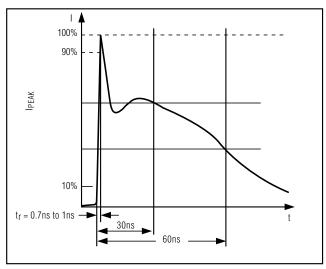


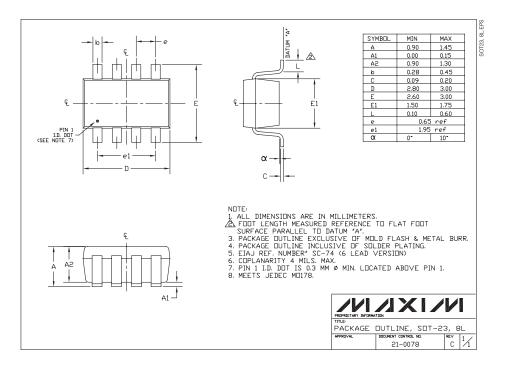
Figure 8. IEC 1000-4-2 ESD Generator Current Waveform

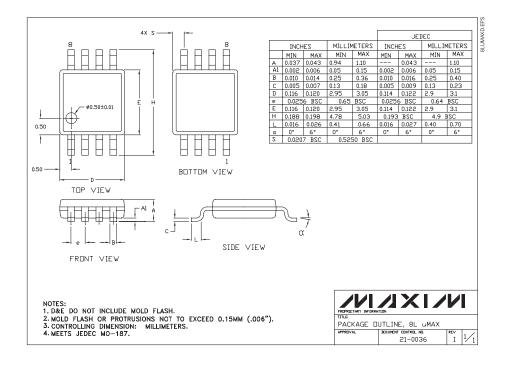
contact that occurs with handling and assembly during manufacturing. Of course, all pins require this protection during manufacturing, not just RS-232 inputs and outputs. Therefore, after PC board assembly, the Machine Model is less relevant to I/O ports.

\_Chip Information

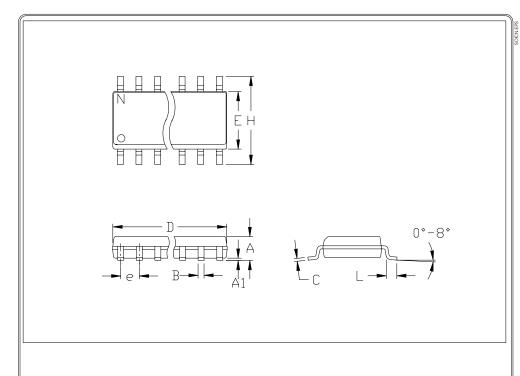
TRANSISTOR COUNT: 128

## **Package Information**





## Package Information (continued)



	INC	HES	MILLIM	<u>ieters</u>
	MIN	MAX	MIN	MAX
А	0.053	0.069	1.35	1.75
A1	0.004	0.010	0.10	0.25
В	0.014	0.019	0.35	0.49
С	0.007	0.010	0.19	0.25
6	0.0	)50	1.6	27
Ε	0.150	0.157	3.80	4.00
Н	0.228	0.244	5.80	6.20
h	0.010	0.020	0.25	0.50
L	0.016	0.050	0.40	1.27

	INCHES		MILLIMETERS			
	MIN	MAX	MIN	MAX	Ν	MS012
D	0.189	0.197	4.80	5.00	8	Α
D	0.337	0.344	8.55	8.75	14	В
D	0.386	0.394	9.80	10.00	16	С

#### NOTES:

- 1. D&E DO NOT INCLUDE MOLD FLASH
  2. MOLD FLASH OR PROTRUSIONS NOT
  TO EXCEED .15mm (.006")
  3. LEADS TO BE COPLANAR WITHIN
  .102mm (.004")

- 4. CONTROLLING DIMENSION: MILLIMETER
  5. MEETS JEDEC MS012-XX AS SHOWN
  IN ABOVE TABLE
  6. N = NUMBER OF PINS

PACKAGE FAMILY DUTLINE: SDIC .150" 21-0041 A

Maxim cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Maxim product. No circuit patent licenses are implied. Maxim reserves the right to change the circuitry and specifications without notice at any time.

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### **MAX3314E**

#### **Part Number Table**

#### Notes:

- 1. See the MAX3314E QuickView Data Sheet for further information on this product family or download the MAX3314E full data sheet (PDF, 256kB).
- 2. Other options and links for purchasing parts are listed at: http://www.maxim-ic.com/sales.
- 3. Didn't Find What You Need? Ask our applications engineers. Expert assistance in finding parts, usually within one business day.
- 4. Part number suffixes: T or T&R = tape and reel; + = RoHS/lead-free; # = RoHS/lead-exempt. More: See full data sheet or Part Naming Conventions.
- 5. \* Some packages have variations, listed on the drawing. "PkgCode/Variation" tells which variation the product uses.

Part Number	Free Sample	Buy Direct	Package: TYPE PINS SIZE  DRAWING CODE/VAR *	Temp	RoHS/Lead-Free? Materials Analysis
MAX3314EEKA-T					RoHS/Lead-Free: No
MAX3314EEKA					RoHS/Lead-Free: No
MAX3314EESA+T				-40C to +85C	RoHS/Lead-Free: Yes
MAX3314EESA+			SOIC;8 pin;.150" Dwg: 21-0041B (PDF) Use pkgcode/variation: S8+4*	-40C to +85C	RoHS/Lead-Free: Yes Materials Analysis
MAX3314ECSA+T				-40C to +85C	RoHS/Lead-Free: Yes
MAX3314ECSA+			SOIC;8 pin;.150" Dwg: 21-0041B (PDF) Use pkgcode/variation: S8+4*	-40C to +85C	RoHS/Lead-Free: Yes Materials Analysis
MAX3314ECSA			SOIC;8 pin;.150" Dwg: 21-0041B (PDF) Use pkgcode/variation: S8-4*	-40C to +85C	RoHS/Lead-Free: No Materials Analysis

MAX3314ECSA-T	SOIC;8 pin;.150" Dwg: 21-0041B (PDF) Use pkgcode/variation: S8-4*	-40C to +85C	RoHS/Lead-Free: No Materials Analysis
MAX3314EESA-T		-40C to +85C	RoHS/Lead-Free: No
MAX3314EESA	SOIC;8 pin;.150" Dwg: 21-0041B (PDF) Use pkgcode/variation: S8-4*	-40C to +85C	RoHS/Lead-Free: No Materials Analysis
MAX3314EEKA#TG16		-40C to +85C	RoHS/Lead-Free: No
MAX3314ECKA	SOT-23;8 pin; Dwg: 21-0078F (PDF) Use pkgcode/variation: K8F-4*	-40C to +85C	RoHS/Lead-Free: No Materials Analysis
MAX3314ECKA-T	SOT-23;8 pin; Dwg: 21-0078F (PDF) Use pkgcode/variation: K8F-4*	-40C to +85C	RoHS/Lead-Free: No Materials Analysis
MAX3314ECUA	uMAX;8 pin;3 x 3mm Dwg: 21-0036J (PDF) Use pkgcode/variation: U8-1*	-40C to +85C	RoHS/Lead-Free: No Materials Analysis
MAX3314ECUA-T	uMAX;8 pin;3 x 3mm Dwg: 21-0036J (PDF) Use pkgcode/variation: U8-1*	-40C to +85C	RoHS/Lead-Free: No Materials Analysis
MAX3314EEUA+T	uMAX;8 pin;3 x 3mm Dwg: 21-0036J (PDF) Use pkgcode/variation: U8+1*	-40C to +85C	RoHS/Lead-Free: Yes Materials Analysis
MAX3314EEUA+	uMAX;8 pin;3 x 3mm Dwg: 21-0036J (PDF) Use pkgcode/variation: U8+1*	-40C to +85C	RoHS/Lead-Free: Yes Materials Analysis
MAX3314EEUA	uMAX;8 pin;3 x 3mm Dwg: 21-0036J (PDF) Use pkgcode/variation: U8-1*	-40C to +85C	RoHS/Lead-Free: No Materials Analysis
MAX3314EEUA-T	uMAX;8 pin;3 x 3mm Dwg: 21-0036J (PDF) Use pkgcode/variation: U8-1*	-40C to +85C	RoHS/Lead-Free: No Materials Analysis

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